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09/090,672

COMBINED DECLARATION AND POWER OF ATTORNEY FOR C-I-P PATENT APPLICATION

As a below named inventor, I hereby declare that.

04/June/1998

My residence, post office address and citizenship are as stated below next to my name.

			is listed below) or an original, first and h is claimed and for which a patent is
sought on the in	vention entitled IgA	EPHROPATHY-RELATED DN	A Patent and for winer a patent is
		, the specification of whi	
is attached	i hereto.	•	
		as Application No	and
	led on		
	y state that I have reviewe ims, as amended by any amer		s of the above-identified specification,
I ackno	wledge the duty to disclose int	formation which is material to pa	atentability as defined in 37 CFR §1.56.
for patent or inv	entor's certificate listed below		Code, §119 of any foreign application(s) we any foreign application for patent or the priority is claimed:
Country	Application No.	Filed (Day/Mo./Yr.)	(Yes/No) Priority Claimed
Japan	Pat. Hei. 8-325763	05/December/1996	Yes
below and, insof States application the duty to disclo	ar as the subject matter of ea n in the manner provided by to se material information as de	ch of the claims of this applicate the first paragraph of Title 35, United in Title 37, Code of Feder	of any United States application(s) listed tion is not disclosed in the prior United United States Code §112, I acknowledge al Regulations, §1.56(a) which occurred ational filing date of this application:
Application No.	Filed (Day/Mo./Y	r.) Status (Paten	ted/Pending/Abandoned)
PCT/JP97/0446	68 05/December/19	97	Pending

I hereby appoint the practitioners associated with the firm and Customer Number provided below to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith, and direct that all correspondence be addressed to the address associated with that Customer Number:

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FITZPATRICK, CELLA, HARPER & SCINTO Customer Number: 05514

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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COMBINED DECLARATION AND POWER OF ATTORNEY FOR C-I-P PATENT APPLICATION

As a below named inventor, I hereby declare that.

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I believe	I am the original, first and so	le inventor (if only one name	is listed below) or an original, first and
joint inventor (if	plural names are listed below	v) of the subject matter which	n is claimed and for which a patent is
sought on the inve	ention entitled	, the specification of whi	ch
X is attached	hereto	, the specification of whi	Cii
		as Application No.	and
was amende	ed on	_ (if applicable).	
•	state that I have reviewed ms, as amended by any amend		of the above-identified specification,
I acknow	ledge the duty to disclose info	rmation which is material to pa	atentability as defined in 37 CFR §1.56.
for patent or inve	ntor's certificate listed below		Code, §119 of any foreign application(s) wany foreign application for patent or h priority is claimed:
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